

# HVD191

Silicon Epitaxial Planar Pin Diode for High Frequency Attenuator

REJ03G0015-0200 Rev.2.00 Jan 20, 2006

### Features

- Low capacitance. (C = 0.37 pF max)
- Low forward resistance. (rf =  $2.5 \Omega \text{ max}$ )
- Super small Flat Lead Package (SFP) is suitable for surface mount design.

### **Ordering Information**

Type No.	Laser Mark	Package Name	Package Code	
HVD191	H2	SFP	PUSF0002ZB-A	

### **Pin Arrangement**

1 [	Cathode mark Mark H2 2	1. Cathode
		2. Anode



## **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Reverse voltage	V <sub>R</sub>	30	V
Forward current	I <sub>F</sub>	100	mA
Power dissipation	Pd	150	mW
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	℃

### **Electrical Characteristics**

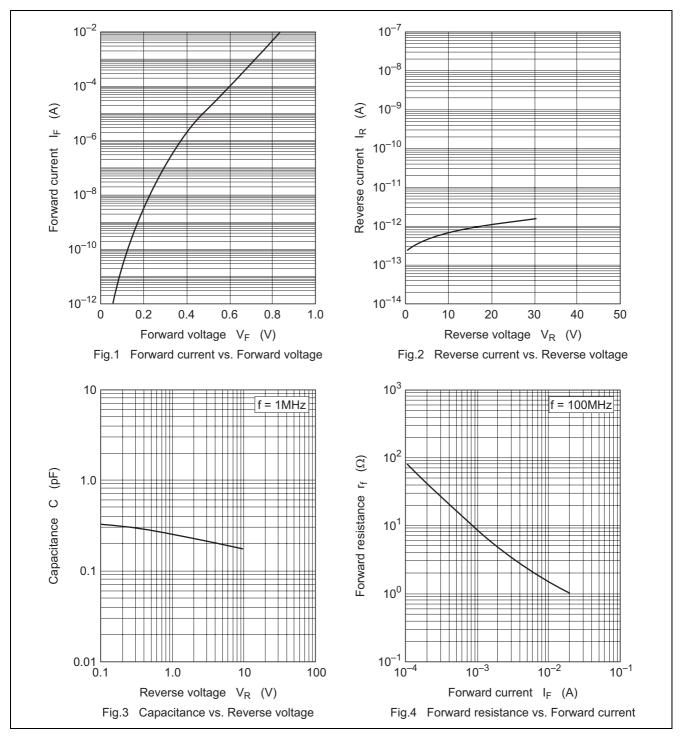
 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Forward voltage	V <sub>F</sub>	_		1.0	V	I <sub>F</sub> = 10 mA
Reverse current	I <sub>R</sub>	_	—	100	nA	V <sub>R</sub> = 30 V
Capacitance	С	_	—	0.37	pF	$V_R = 1 V$ , f = 1 MHz
Forward resistance	r <sub>f</sub>		_	2.5	Ω	I <sub>F</sub> = 10 mA, f = 100 MHz

Note: For SFP package, the material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

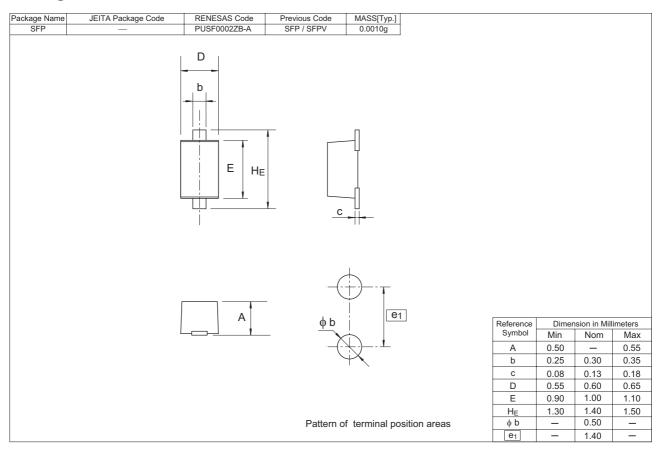


### **Main Characteristic**





### **Package Dimensions**





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